



System's Performances in BI

Volker Schramm on behalf of the BI group

Special thanks to:

Enrico Bravin, Ewald Effinger, Rhodri Jones, Tom Levens, Georges Trad, William Viganò, Manfred Wendt, Christos Zamantzas

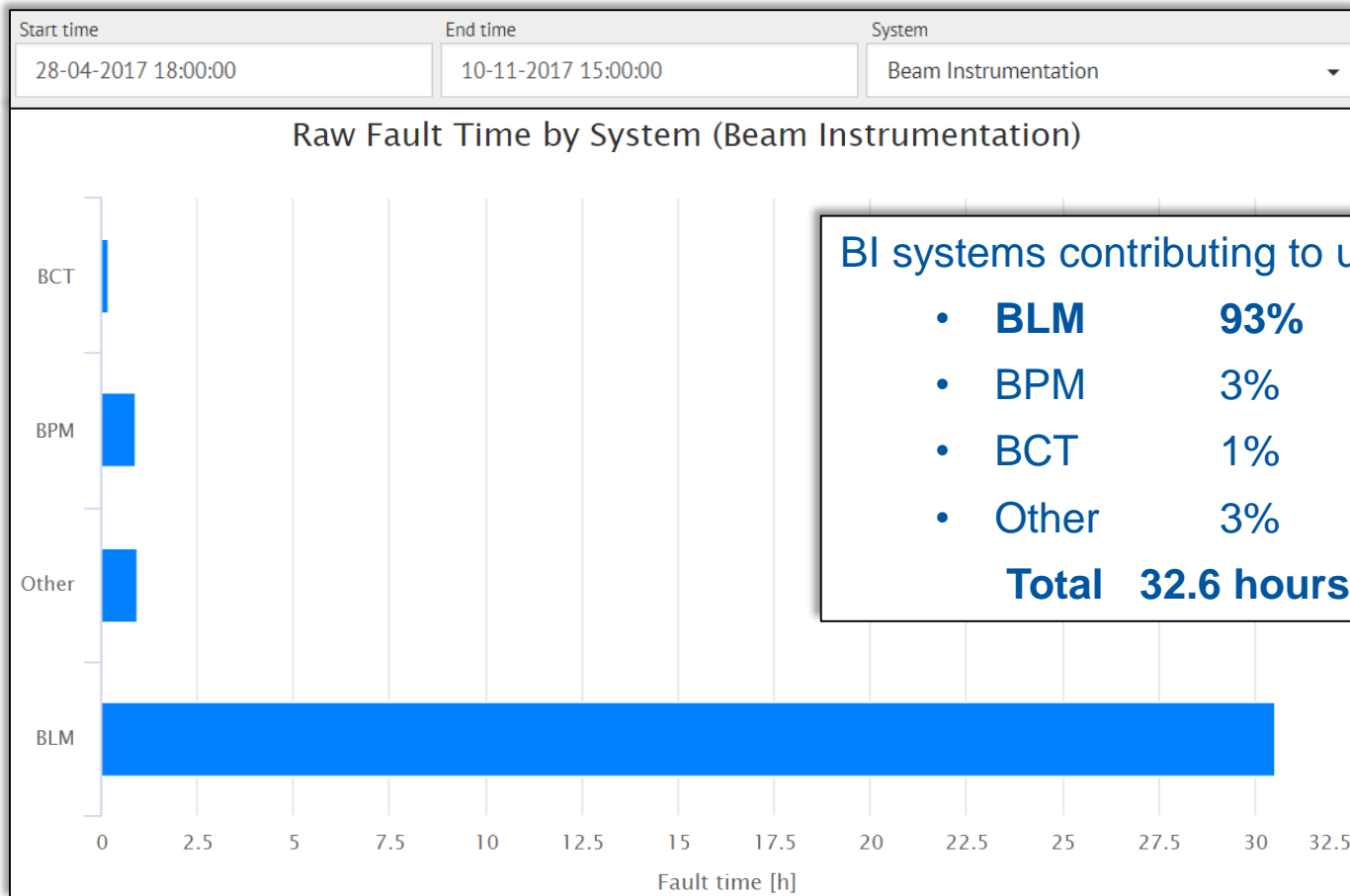
Agenda

- AFT statistics 2017 & previous years
- Faults analysis
- BI past and future efforts
- Conclusion

AFT statistics - 2017

Registered **22** BI faults in 2017 which account to **32h** LHC downtime

The main unavailability contributor is the Beam Loss Monitoring system



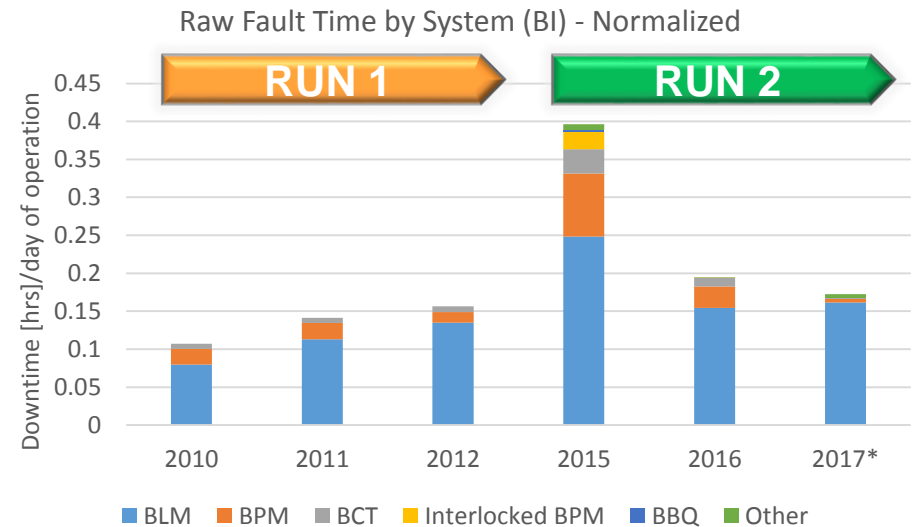
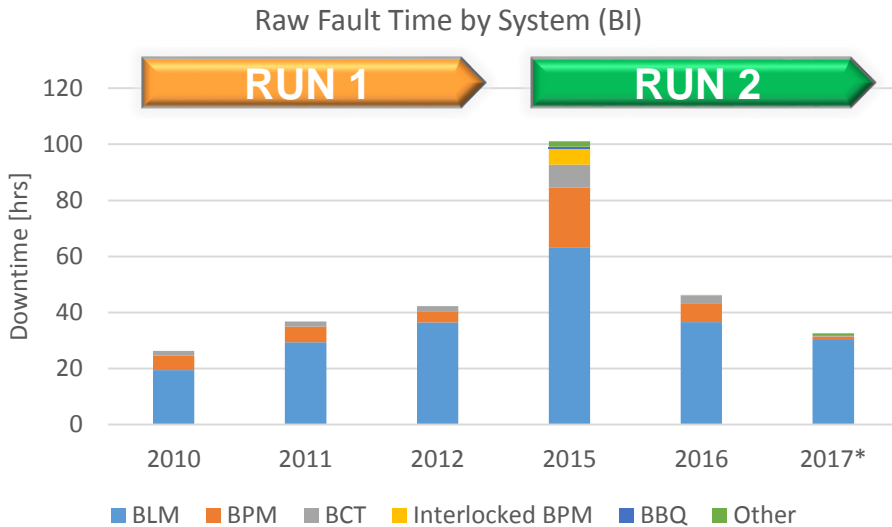
BI systems contributing to unavailability:

- **BLM** **93%** **(18 faults)**
- **BPM** **3%** **(1 fault)**
- **BCT** **1%** **(1 fault)**
- **Other** **3%** **(2 faults)**

Total 32.6 hours

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AFT statistics – previous years



- BI availability increased for the 2nd year in a row (all systems!)
- 2017: Highest availability ever achieved for BPMs and BCTs
 - Strong positive trend since 2015 (consistent AFT recording since 2015)
- The BLM normalized downtime is almost constant during 2016 and 2017

Year	Days with fills
2010	245
2011	260
2012	270
2013	43
2014	0
2015	255
2016	237
2017	189*

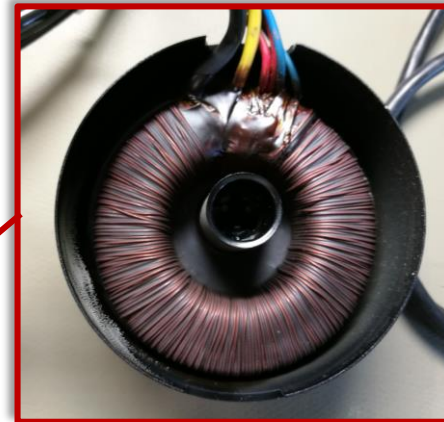
➔ Focus on the performance of the BLM

*2017: 28/04 – 10/11

Faults Analysis - BLM

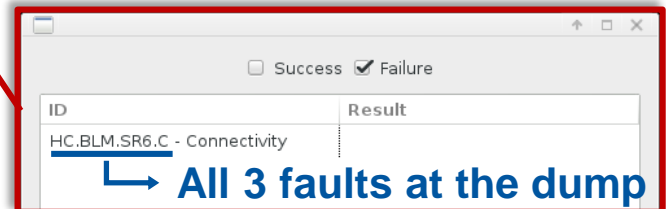
Detailed BLM faults in 2017:

Issue	2017			
	#	%	downtime	%
SEU (surface)	4	22%	04h 40m	15%
VME Power Supply Fail	1	6%	07h 47m	25%
Connection Lost: FESA/VME/CPU	1	6%	00h 04m	0%
HV Power Supply Drop				
HV Power Supply Noise				
Sanity Error: Communication/VME	4	22%	01h 23m	5%
Sanity Error: IC	1	6%	00h 29m	2%
Sanity Error: LIC				
Sanity Error: SEM	3	17%	13h 54m	46%
BLECF optical link issues	4	22%	02h 13m	7%
BLETC optical link issues				
Other optical link issues				
Other				
	18		1d 06h 32m	



Failed transformer

~50% Sanity Check related faults



Failed Connectivity Test

Faults Analysis - BLM

Detailed BLM faults of previous years: separate **AFT** & **BI-BL** accounting

- Throughout all years high number of Optical Link and Sanity Check related faults
- Own accounting helps to identify weak parts and to react earlier (e.g. Optical Link)

Issue	2012		2015		2016		2017	
	AFT	Jira	AFT	Jira	AFT	Jira	AFT	Jira
SEU (surface)	3	3	2		1		4	
VME Power Supply Fail	1	1			1		1	
Connection Lost: FESA/VME/CPU	5	6	7		1		1	
HV Power Supply Drop		4						
HV Power Supply Noise			3		2			
Sanity Error: Communication/VME	3	9	6		2		4	
Sanity Error: IC		3	1				1	
Sanity Error: LIC		6						
Sanity Error: SEM	5	10	5		4		3	
BLECF optical link issues	1	7					4	
BLETC optical link issues	3	11	1		4			
Other optical link issues	2	10						
Other	2		2		1			
	25*	70	27		16		18	
	1d 12h 28m		2d 15h 16m		1d 12h 36m		1d 06h 32m	



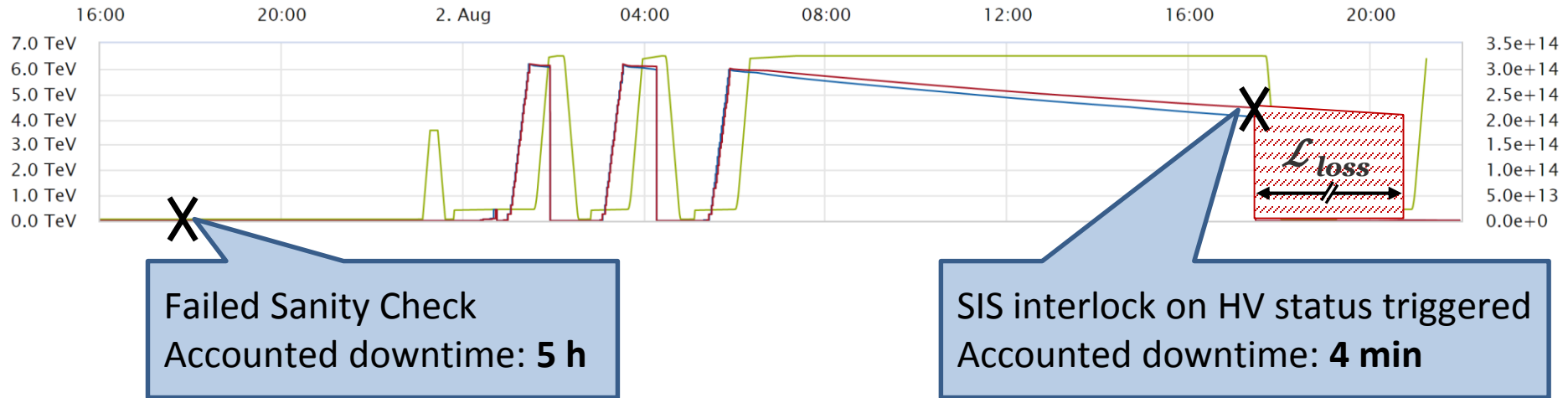
3 main fault cases:

- **Power supplies:**
Constant low failure rate
- **SEMs (at the dump):**
Constant high failure rate
- **Optical links:**
Decreased, then in Run2 constant low failure rate

*No consistent AFT recording (Run1)

Faults Analysis – 1 example

2 BLM failures within 30 hours this August:



- System fault detected before it can lead to a dump (function fulfilled)
- \mathcal{L}_{loss} ? → 'Equivalent to 5 hours of scheduled operation'

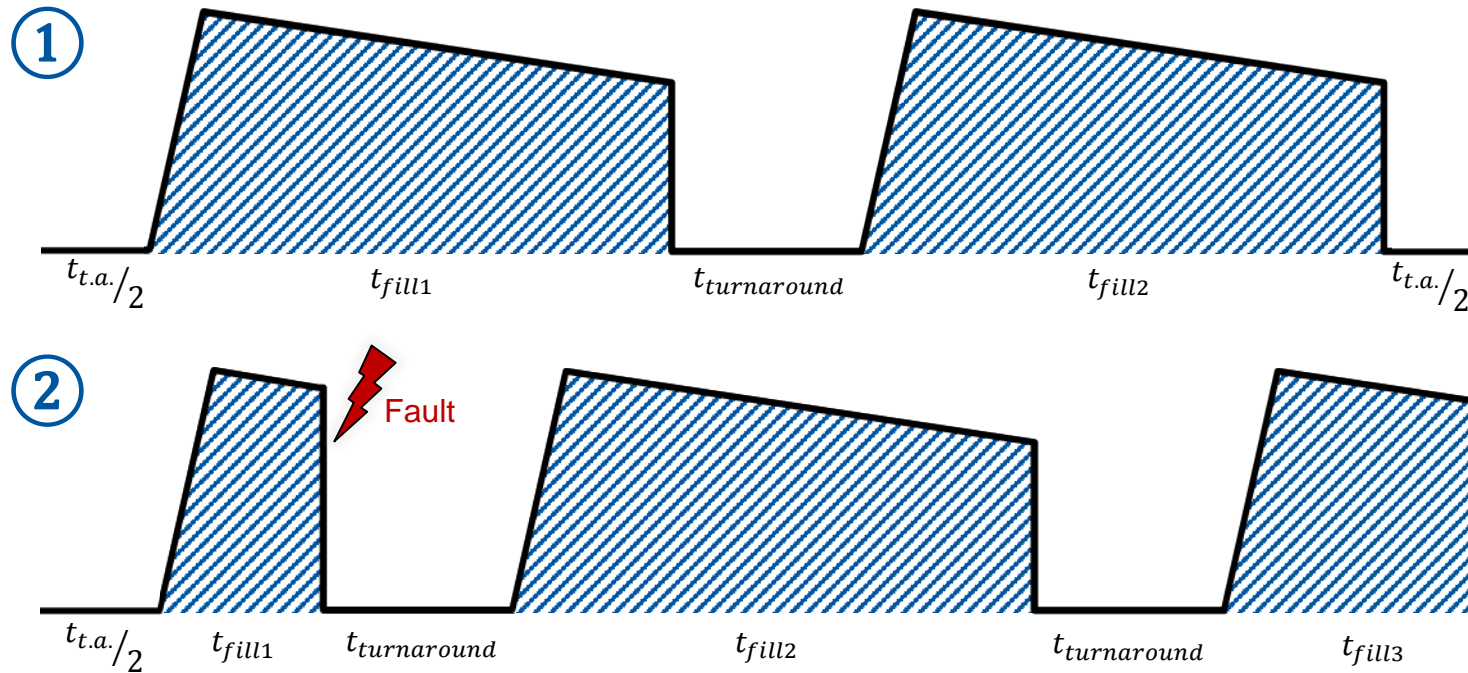


- Fault lead to unscheduled beam dump (false dump)
- \mathcal{L}_{loss} ? → 'Equivalent to >>4min of scheduled operation' ?

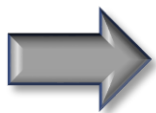
- **How to quantify the luminosity loss?**
- **How to scale availability and luminosity?**

Faults Analysis – 1 example

Example of two 12-hour fills as intended and the same scenario with a fault in the first fill:



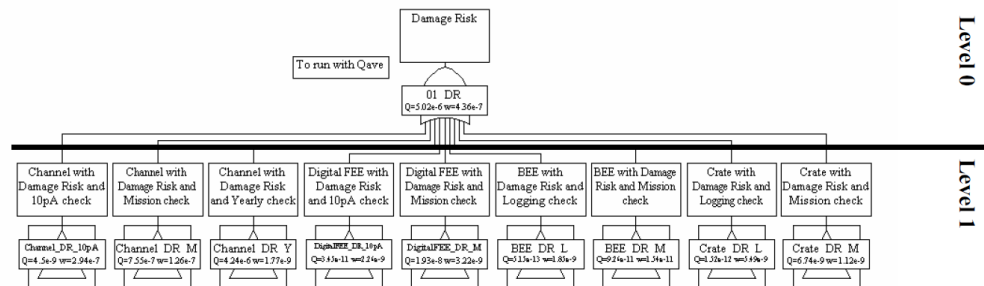
By using intensities of a typical 12h13min fill at 6.5 TeV [03/09/2017,4:17am] as well as $t_{turnaround} = 6.2h$ the integrated area below the fills is $\geq 14\%$ bigger for the 1st scenario



It is worth to invest in diagnostics and continuous system checks

Past Efforts – LHC BLM

- 2005** ➤ Dependability analysis:
- Prediction
 - FMECA
 - FTA
 - Sensitivity Analysis



Gianluca Guaglio, PhD thesis, 2005

- 2008** ➤ Redesign of the backend mezzanine

- 2012** ➤ Preventive system fault analysis

- Daily automatic mails

- Jira failure logging

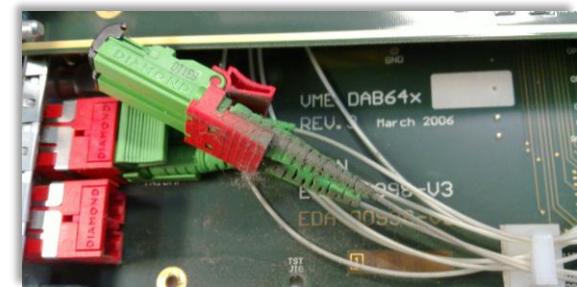
Optical link errors

Card	CF Ser	TC Ser	CS Ser	CRC_COMP		LK1 Err		LK2 Err		LK1 Lost		LK2 Lost		FID.COMP	
				A	B	A	B	A	B	A	B	A	B		
2.L.1	0371	0328	16429131501618539521	17437937815547463425	0	0	0	0	0	0	42	0	0	0	0
3.R.14	0492	0488	10664523978582786561	16861477063165457409	0	0	0	0	0	0	0	0	1	0	0
4.L.6	0642	0591	10736581572621763841	14267403677825781249	1	0	1	0	0	0	0	0	0	0	0
7.C.5	0803	0682	9151314503787382017	7854277808467274753	0	0	0	0	0	0	0	0	1	0	0

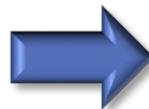
- 2013** ➤ 1st big maintenance intervention:

(LS1)

- Preventive exchanges: Cables, detectors, cards, fans
- Acquisition electronics modification & recalibration
- Clean-up: Optical adaptors, connectors
- Shuffle of optical links & firmware modification



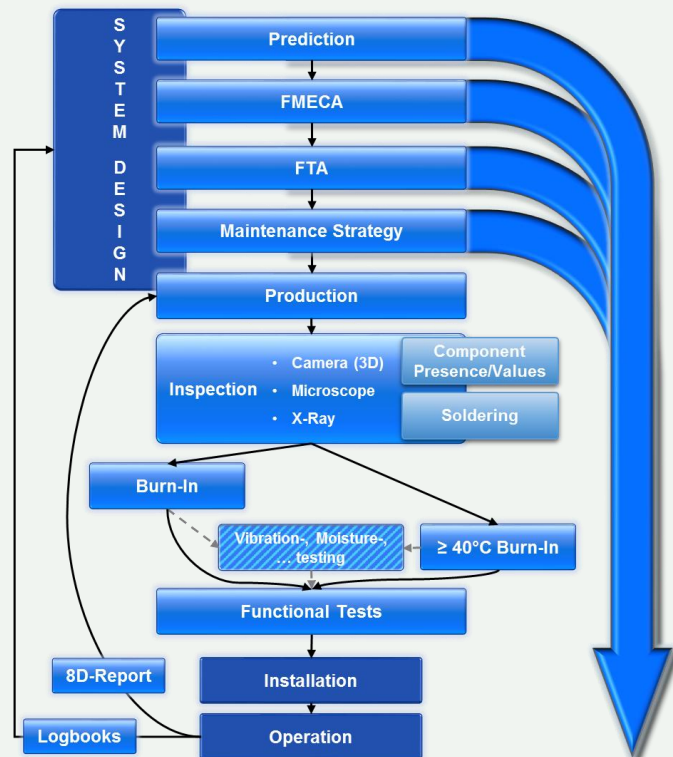
- 2017** ➤ Dependability analysis update (PhD)



Past Efforts – LHC BLM

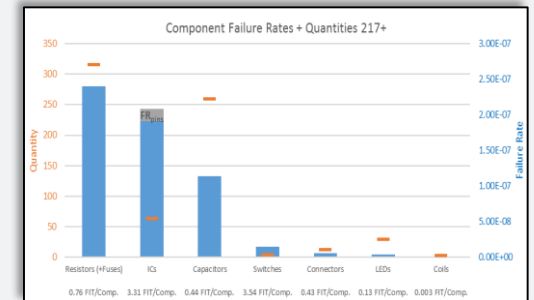
Ongoing PhD to study and improve the LHC BLM system. Results will be projected to enhance the injector's upgrade and the new VFC processing card:

Methodology for dependable PCB design, production, installation & operation



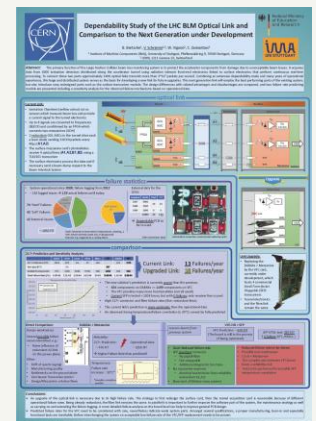
Dependability analysis update of the LHC BLM

- Reliability Prediction ✓
- FMECA + FTA (ongoing)
 - Assign system checks
- Failure analysis ✓



Failure analysis of the optical link → Analysis of the new VFC card (ongoing)

- Optical link weaknesses identified ✓
- Improvements for the VFC suggested ✓
- Reliability prediction of the VFC ✓
- Definition of a testing strategy for the VFC (ongoing)



Presented at ARW, Versailles, Oct '17

Future Efforts – VFC upgrade

Installation of the VFC card to upgrade the surface processing card

- Eliminate system weaknesses
- Adding extra functionalities
- Testing and qualification prior to installation ! Demonstrate low failure rate !

VFC availability/reliability:

- Higher number of components
- More functionalities
- Better reliability

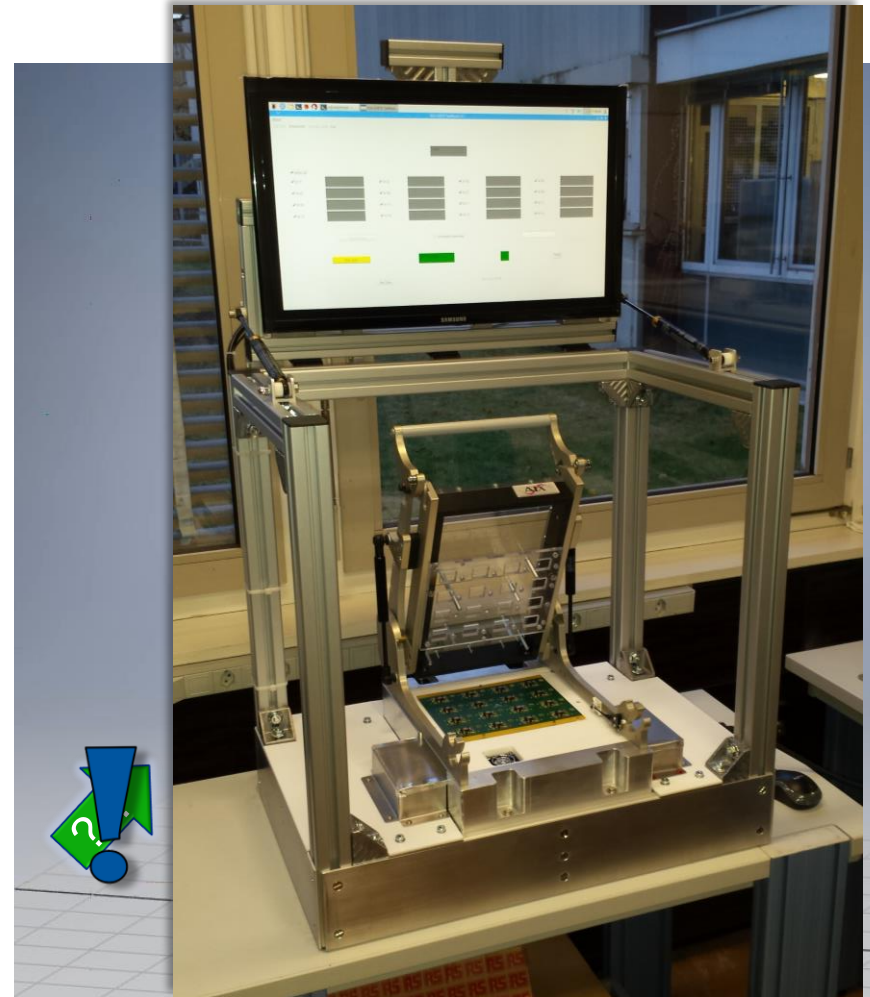


Future Efforts – Testing

Functional and reliability tests:



Functional tester for the VFC-HD card



Reliability tester of VFC power supplies

Future Efforts – Testing

W. Viganò



Climate chamber testing:

Dynamic climate chamber for rapid temperature changes with humidity control (BINDER MKF 240)
Temp.: -40 °C to 180 °C RH: 10 % to 98 %

Local PC equipped with APTCOM3 control software for remote control, temperature profiles definition and various settings.



Other available resources permanently installed at the climate chamber area:

- Working table
- Power sockets
- Optical fibers for all machine timings
- Ethernet hub
- USB hub

Optional resources

- PicoScope
- Function generator
- Others...

Future Efforts – Sanity Check

Optimising the Sanity Check sequence:

- Merge 5 sequence steps into 4
- Enable to perform checks of only 1 group
- Upgrades of the code in the long term

→ **20%** time saving

→ Up to **75%** time saving

The screenshot shows a software window titled 'Status Application' with a 'Beam monitor' section. It displays 'Accelerator Mode' and 'Beam Mode' information, and a 'Global Status' bar indicating a check is running at 06.12.2017 10:47:07. Below this is a table of checks categorized into 'Checks connected to BIS' (MCS and Sanity Checks) and 'Expert checks'. The table lists various crates (SR1.L to SR8.I) and their status across different check categories. A legend at the bottom indicates status colors: OK (green), OK <12h (light green), OK Block BP (yellow), BP removed (purple), Fail (red), Under Test (orange), and No Data (grey).

Crates	Checks connected to BIS		Internal Beam Permit	Expert checks						External Beam Permit
	Consistency	Connectivity		CFC_TEST	RST_DAC	RST_GOH	RST_FPGA	STOP_HV	MANUAL_CTR	
SR1.L	OK	BP removed	OK	OK	OK	OK	OK	OK	OK	Fail
SR1.C	OK	BP removed	OK	OK	OK	OK	OK	OK	OK	Fail
SR1.R	OK	BP removed	OK	OK	OK	OK	OK	OK	OK	Fail
SR2.L	OK	BP removed	OK	OK	OK	OK	OK	OK	OK	Fail
SR2.C	OK	BP removed	OK	OK	OK	OK	OK	OK	OK	Fail
SR2.R	OK	BP removed	OK	OK	OK	OK	OK	OK	OK	Fail
SR2.I	OK	BP removed	OK	OK	OK	OK	OK	OK	OK	Fail
SR3.L	OK	BP removed	OK	OK	OK	OK	OK	OK	OK	Fail
SR3.C	OK	BP removed	OK	OK	OK	OK	OK	OK	OK	Fail
SR3.R	OK	BP removed	OK	OK	OK	OK	OK	OK	OK	Fail
SX4.L	OK	BP removed	OK	OK	OK	OK	OK	OK	OK	Fail
SX4.C	OK	BP removed	OK	OK	OK	OK	OK	OK	OK	Fail
SX4.R	OK	BP removed	OK	OK	OK	OK	OK	OK	OK	Fail
SR5.L	OK	BP removed	OK	OK	OK	OK	OK	OK	OK	Fail
SR5.C	OK	BP removed	OK	OK	OK	OK	OK	OK	OK	Fail
SR5.R	OK	BP removed	OK	OK	OK	OK	OK	OK	OK	Fail
SR6.L	OK	BP removed	OK	OK	OK	OK	OK	OK	OK	Fail
SR6.C	OK	BP removed	OK	OK	OK	OK	OK	OK	OK	Fail
SR6.R	OK	BP removed	OK	OK	OK	OK	OK	OK	OK	Fail
SR7.L	OK	BP removed	OK	OK	OK	OK	OK	OK	OK	Fail
SR7.C	OK	BP removed	OK	OK	OK	OK	OK	OK	OK	Fail
SR7.R	OK	BP removed	OK	OK	OK	OK	OK	OK	OK	Fail
SR7.E	OK	BP removed	OK	OK	OK	OK	OK	OK	OK	Fail
SR8.L	OK	BP removed	OK	OK	OK	OK	OK	OK	OK	Fail
SR8.C	OK	BP removed	OK	OK	OK	OK	OK	OK	OK	Fail
SR8.R	OK	BP removed	OK	OK	OK	OK	OK	OK	OK	Fail
SR8.I	OK	BP removed	OK	OK	OK	OK	OK	OK	OK	Fail

Checks sequence:

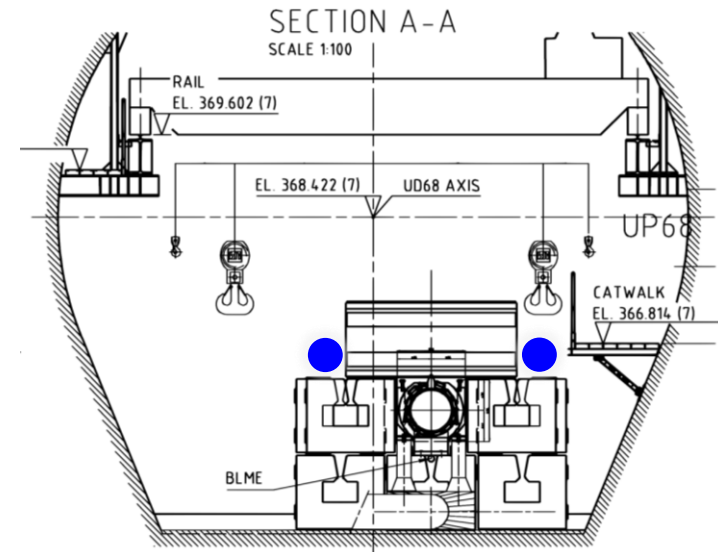
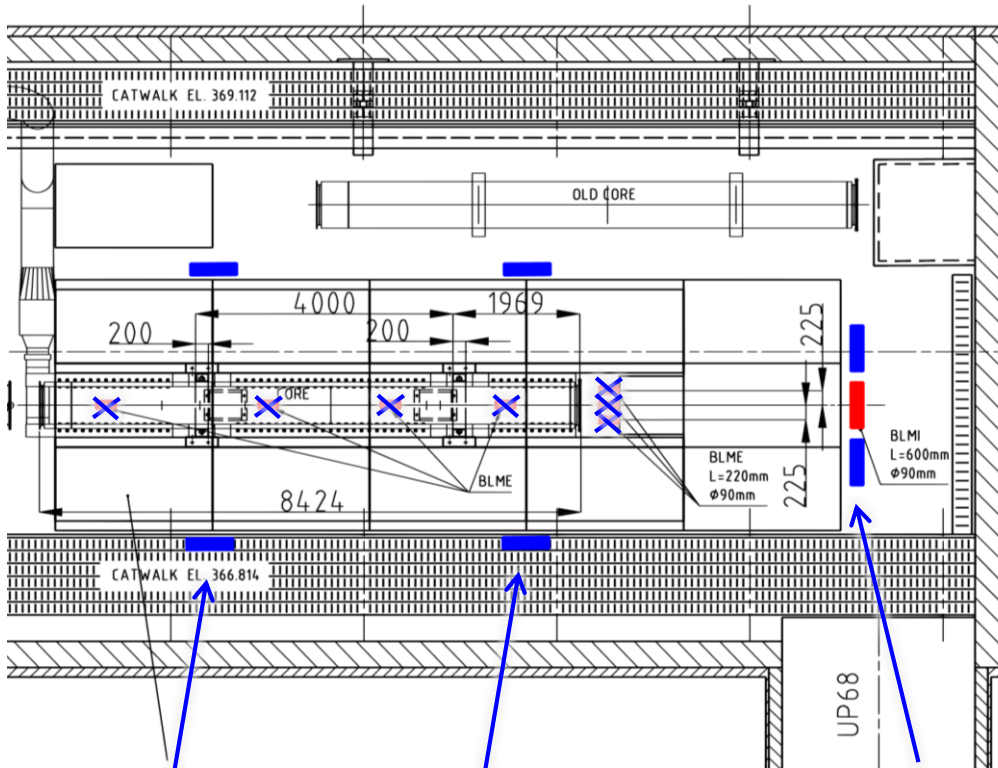
1. Each point center crate
2. Each point left crate
3. Each point right crate
4. Injection crate
5. Extra crate in point 7

→ Merge steps 4 and 5

Future Efforts – Dump Upgrade

Proposal of 6 new BLM: LIC and/or IC with small filter (factor 20)

C. Wiesner
W. Bartmann



2 BLM on each side (right/left)

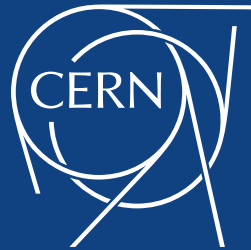
2 additional BLM behind dump

→ Exact positions have been defined with ABT. Radiation tolerant cabling to be added locally.

Conclusion

- In 2017 a better availability was achieved than in previous years
 - Very strong performance of BCTs and BPMs
 - Future efforts need to focus on the BLM which contributed >90% of BI downtime
- Various measures are put in place:
 - Constant maintenance and exchange of less reliable systems
 - Preventive system fault analysis & failure logging
 - System upgrades which include:
 - Functional tests before installation
 - Component reliability testing
 - System burn-in-/reliability testing
- Diagnostics and performing system checks can reduce availability but can in the same way increase luminosity

Thank you for your attention

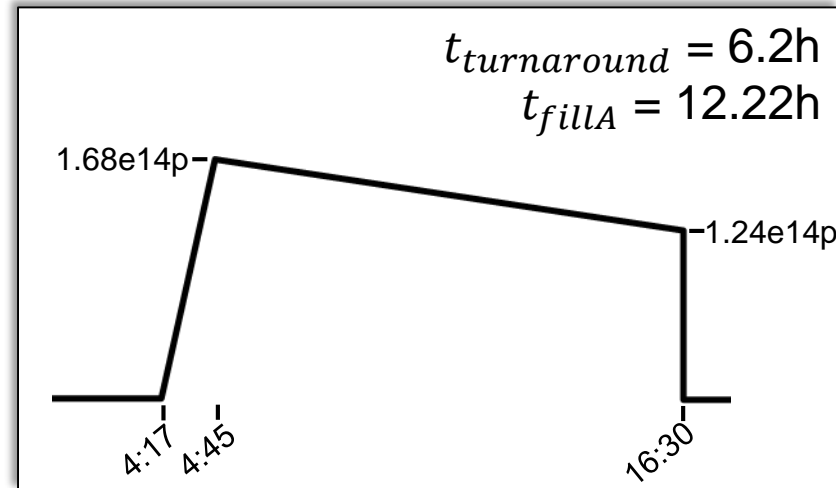
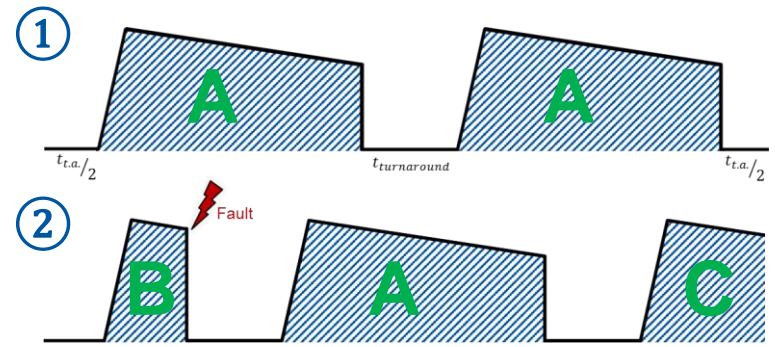


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Backup

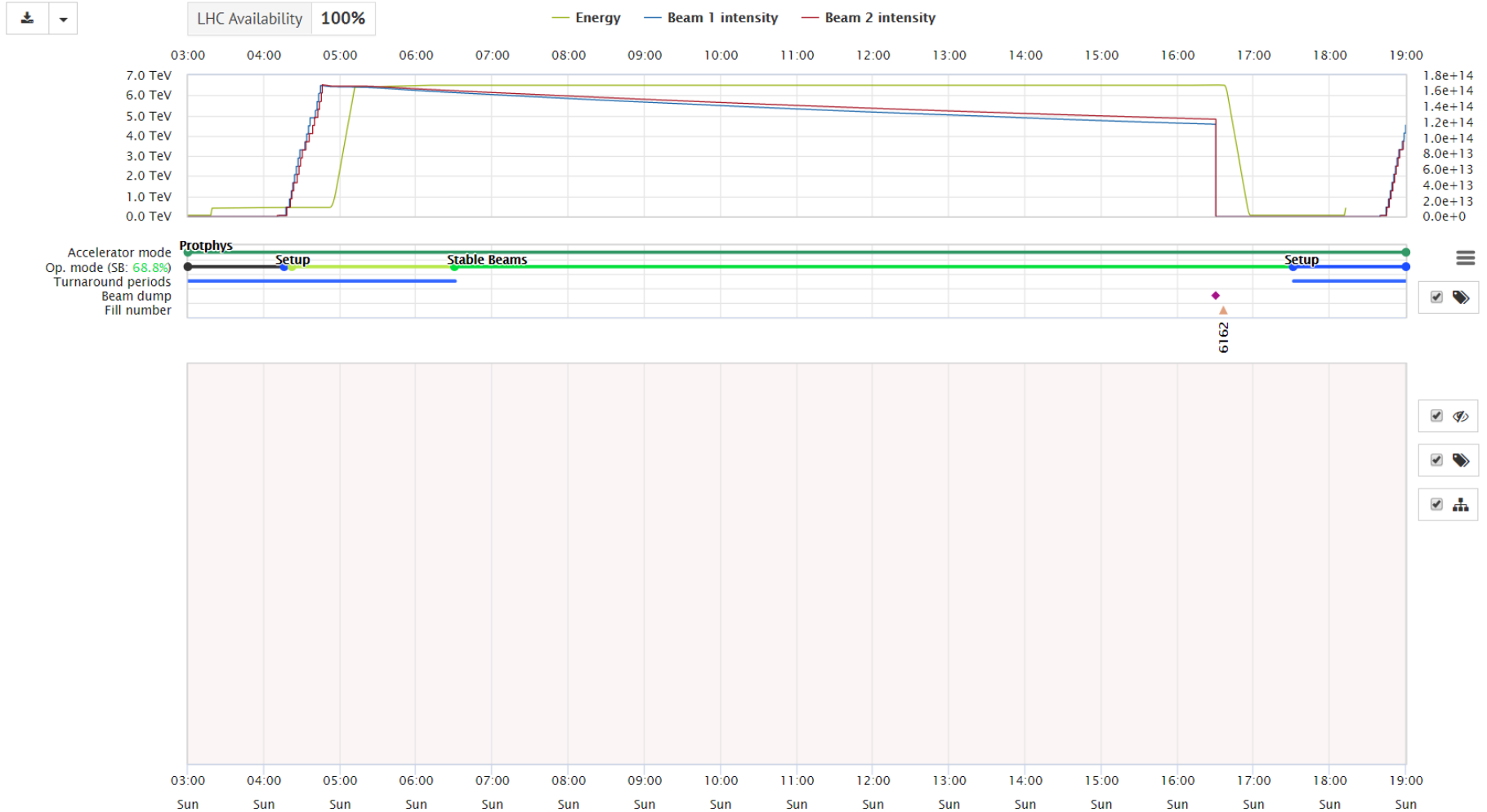
Calculation of the ~ 14% reduced luminosity:

- $\mathcal{L}_{loss} = 2A - (A + B + C) = A - B - C$
- $t_{total} = 2 * 12h + 2 * 6.2h = 36.4h$
- $t_C = 36.6h - 12h - 2.5 * 6.2h - t_B \rightarrow t_B + t_C = 9.1h \rightarrow$ Highest \mathcal{L} for $t_B = t_C = 4.55h$
- $A = \frac{0.46h * 1.68e14p}{2} + 11.75h * 1.24e14p + \frac{11.75h * 0.44e14p}{2} = 17.55e14h * p$
- $B = C = \frac{0.46h * 1.68e14p}{2} + 4.08h * 1.24e14p + \frac{4.08h * 0.44e14p}{2} = 6.35e14h * p$
- ① $2A = 35.1e14$ ② $A + B + C = 30.24e14$
 \rightarrow " \mathcal{L}_{loss} " = $4.85e14 \approx 14\%$



Backup

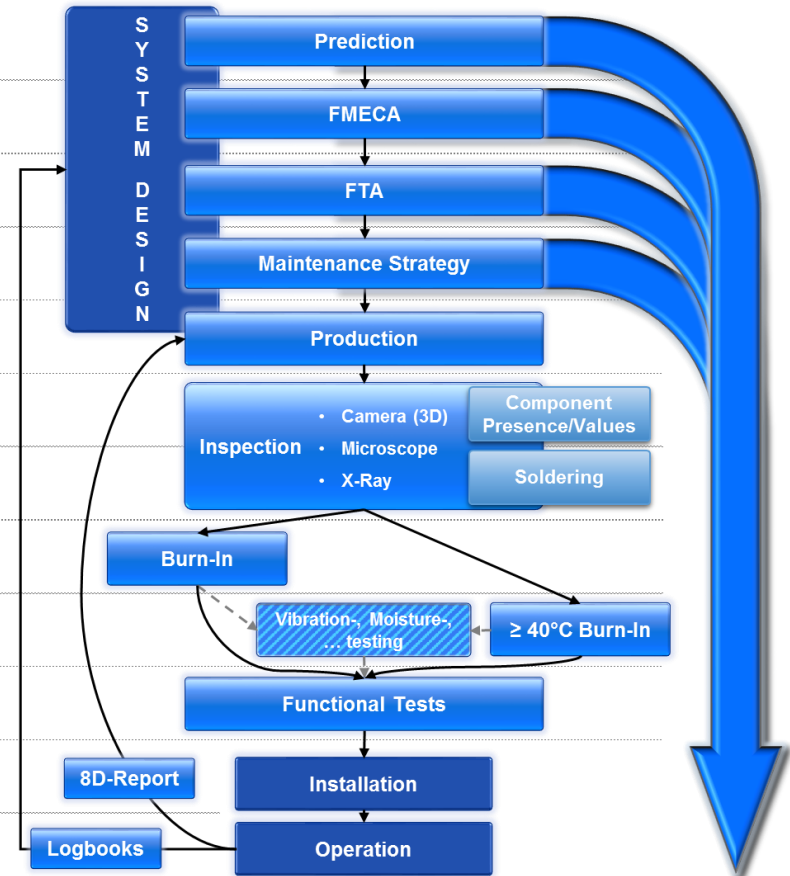
Example of a 12-hour fill at 6.5 eV:



Backup

Methodology PCB design:

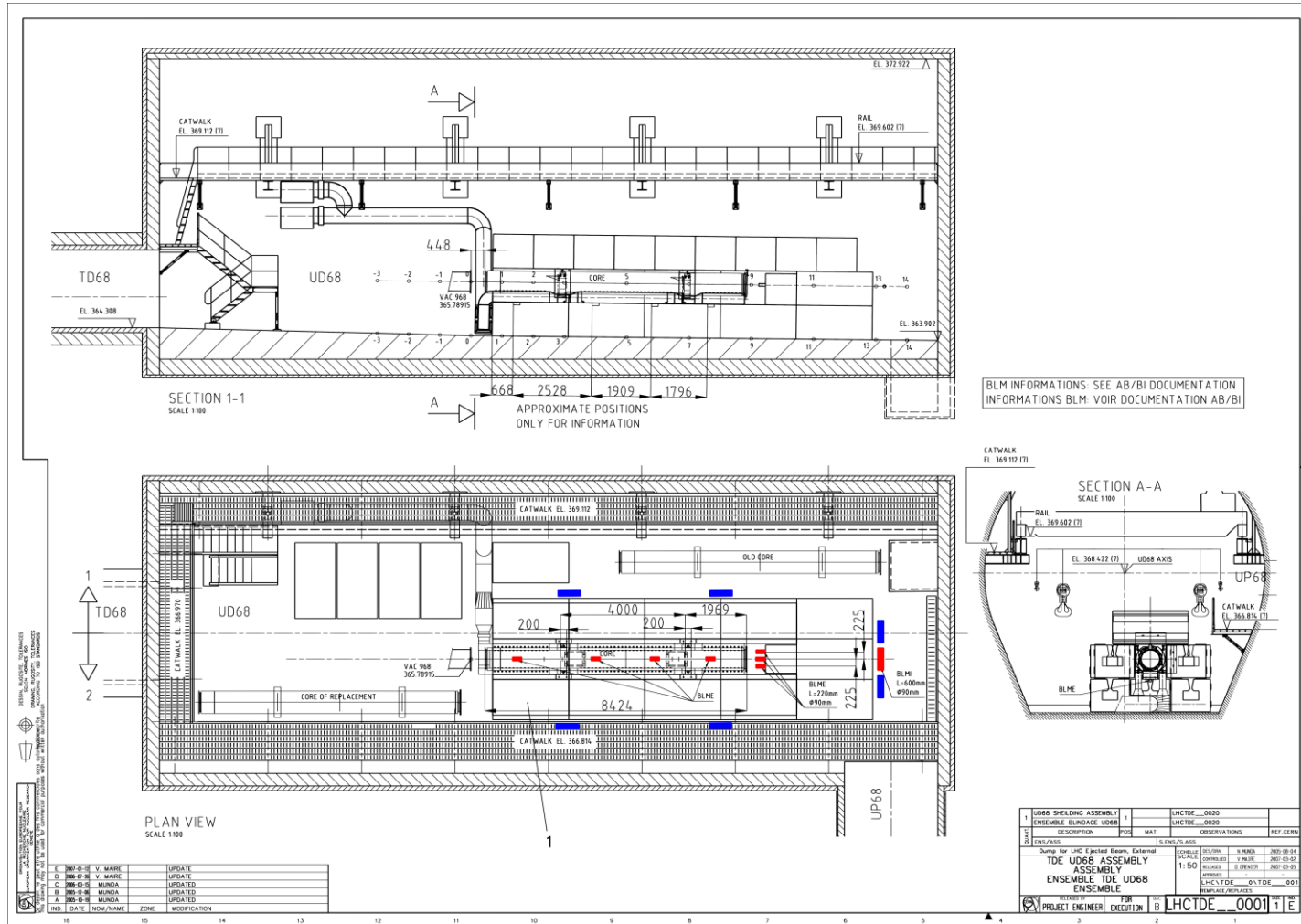
#	Actions	Q_{ind}	Q_{tot}
1	FMECA performed/foreseen	0.4	0.5
	Additional FTA	0.1	
2	Maintenance strategy defined		0.2
3	Well-known manufacturer (CERN experience)		0.2
4	Inspection	0.2	0.4
	Camera (3D)		
	Microscope / X-Ray (BGA)	0.2	
5	Burn-In at operating temperature	0.5	1
	At $\geq 40^{\circ}\text{C}$	0.5	
6	Functional PCB Tests		0.2
7	Failure analysis of field returns by manufacturers		0.1
8	Failure/Repair logbook; Jira-Tracking		0.4
		$Q_{SUM} (\leq 3)$	3
		AdjustmentFactor $A_Q (0.25 \leq A_Q \leq 1)$	0.250



Backup

Dump Region with BLM:

C. Wiesner
W. Bartmann



Backup